

Cont'd B1

an IC (integrated circuit) module capable of communicating with said external apparatus via said booster unit in a non-contact manner in such a way that said IC module includes IC element and a second coil electrically connected and formed integrally with said IC element for transmitting/receiving data to/from said external apparatus through said first coil formed on said booster unit.

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4. (amended) A non-contact information medium as claimed in claim 1 wherein:
said IC element owns a memory unit.

REMARKS

Claims 1 and 4-11 remain in this application.

Claims 2, 8-11 and 19-20 stand rejected under 35 U.S.C. 112, second paragraph, as being indefinite. This rejection is respectfully traversed for the following reasons.

Claim 1 has been amended to recite "a second coil" to provide antecedent basis.

Claims 2 and 3 have been canceled; and claim 1 has been rewritten to include the distinguishing subject matter

Claims 4-11 now depend from amended claim 1.

Claims 1-22 stand rejected under 35 U.S.C. 102(e) as being anticipated by Emori et al. These rejections are respectfully traversed for the following reasons.

As recited in amended claim 1, by structuring a non-contact information medium by the combination of an on-coil IC chip, in which an IC element and communication antenna are formed integrally with a booster unit, effects of not only communication distance is